

Is Now Part of



# **ON Semiconductor**®

# To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="https://www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="https://www.onsemi.com">Fairchild\_questions@onsemi.com</a>.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized applications, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an ad experson



# FDMS86350ET80 N-Channel PowerTrench<sup>®</sup> MOSFET 80 V, 198 A, 2.4 mΩ

### Features

- Extended T<sub>J</sub> rating to 175°C
- Max  $r_{DS(on)}$  = 2.4 m $\Omega$  at  $V_{GS}$  = 10 V,  $I_D$  = 25 A
- Max  $r_{DS(on)}$  = 3.2 m $\Omega$  at  $V_{GS}$  = 8 V,  $I_D$  = 22 A
- Advanced Package and Silicon combination for low r<sub>DS(on)</sub> and high efficiency
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

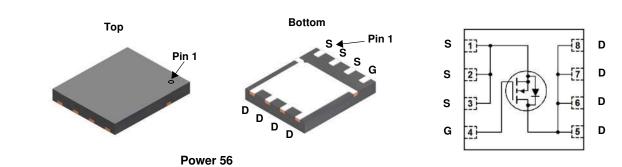


## **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench® process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

### **Applications**

- Primary MOSFET
- Synchronous Rectifier
- Load Switch
- Motor Control Switch



# MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			80	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T <sub>C</sub> = 25 °C	(Note 5)	198		
	-Continuous	T <sub>C</sub> = 100 °C	(Note 5)	140	A	
D	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	25	A	
	-Pulsed		(Note 4)	693		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	864	mJ	
Р	Power Dissipation	T <sub>C</sub> = 25 °C		187	w	
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	3.3	vv	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +175	°C	

### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	0.8	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a	) 45	C/ W

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86350ET	FDMS86350ET80	Power 56	13 "	12 mm	3000 units

January 2015

Units	FDMS86350ET80 N-Channel PowerTrench
V	ÖE
mV/°C	<b>T8</b> (
	, z
μA nA	<u></u>
	lan
V	Ine
mV/°C	I Po
mΩ	werTr
S	ene
	ch <sup>®</sup>
pF	
pF pF pF Ω	0
pF	۲ ۲
Ω	Ē

·D22	Loro dato Voltago Brain Garroni	·DS - • · · , •GS - • •				pur
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			±100	nA
On Char	acteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \ \mu A$	2.5	3.8	4.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		-12		mV/°C
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 25 \text{ A}$		2.0	2.4	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 8 V, I <sub>D</sub> = 22 A		2.5	3.2	mΩ
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 25 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		3.1	3.8	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 25 A		70		S
-	Characteristics			8030		۶E
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ = 1 MHz		8030		pF
C <sub>oss</sub>	Output Capacitance			1370		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			31		pF
Rg	Gate Resistance		0.1	1.1	3	Ω
Switchin	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			50	80	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 40 V, I <sub>D</sub> = 25 A,		34	55	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		40	65	ns
t <sub>f</sub>	Fall Time			11	20	ns
Qg	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		110	155	nC
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 8 V V_{DD} = 40 V,$		90	127	nC
Q <sub>qs</sub>	Gate to Source Charge	I <sub>D</sub> = 25 A		46		nC

**Test Conditions** 

 $I_D = 250 \ \mu$ A, referenced to 25 °C

 $I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$ 

 $V_{DS} = 64 \text{ V}, V_{GS} = 0 \text{ V}$ 

Min

80

Тур

45

Мах

1

### **Drain-Source Diode Characteristics**

Gate to Drain "Miller" Charge

Electrical Characteristics T<sub>J</sub> = 25 °C unless otherwise noted

Parameter

Drain to Source Breakdown Voltage

Breakdown Voltage Temperature

Zero Gate Voltage Drain Current

V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)	0.71	1.2	V	
		V <sub>GS</sub> = 0 V, I <sub>S</sub> = 25 A (Note 2)	0.79	1.3	v	
t <sub>rr</sub>	Reverse Recovery Time	I <sub>E</sub> = 25 A, di/dt = 100 A/μs	63	101	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	$F = 25 \text{ A}, \text{ di/dt} = 100 \text{ A/} \mu \text{s}$	62	100	nC	

Notes:

Q<sub>gd</sub>

Symbol

BV<sub>DSS</sub>

 $\Delta BV_{DSS}$ 

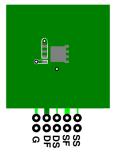
 $\Delta T_J$ 

IDSS

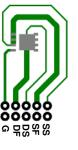
**Off Characteristics** 

Coefficient

1. R<sub>0JA</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0CA</sub> is determined by the user's board design.



a. 45 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.



b. 115 °C/W when mounted on a minimum pad of 2 oz copper.

23

2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

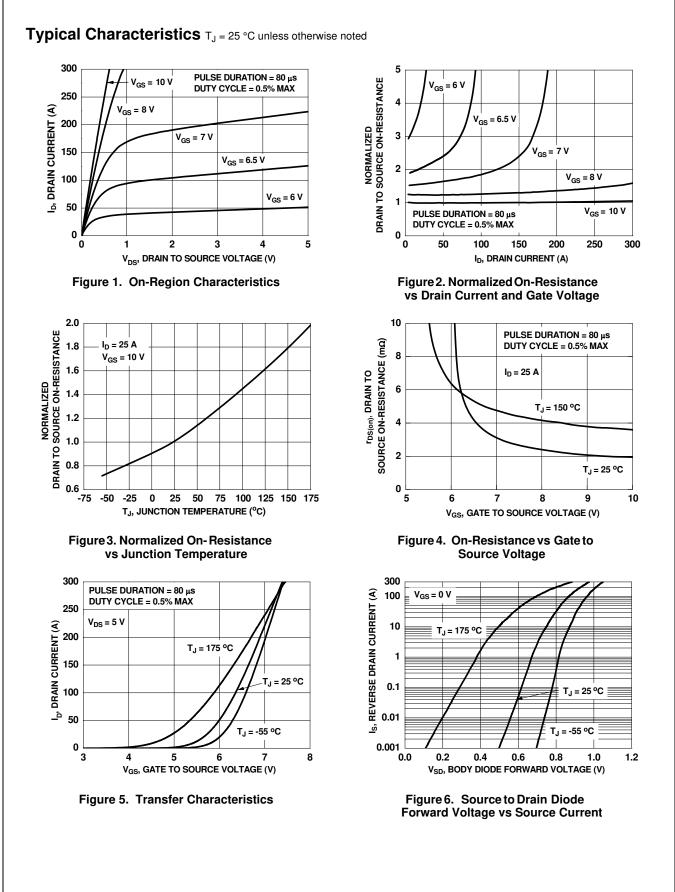
3.  $E_{AS}$  of 864 mJ is based on starting  $T_J$  = 25 °C, L = 3 mH,  $I_{AS}$  = 24 A,  $V_{DD}$  = 80 V,  $V_{GS}$  = 10 V, 100% test at L = 0.1 mH,  $I_{AS}$  = 74 A.

4. Pulse Id please refer to Fig.11 SOA curve for more details.

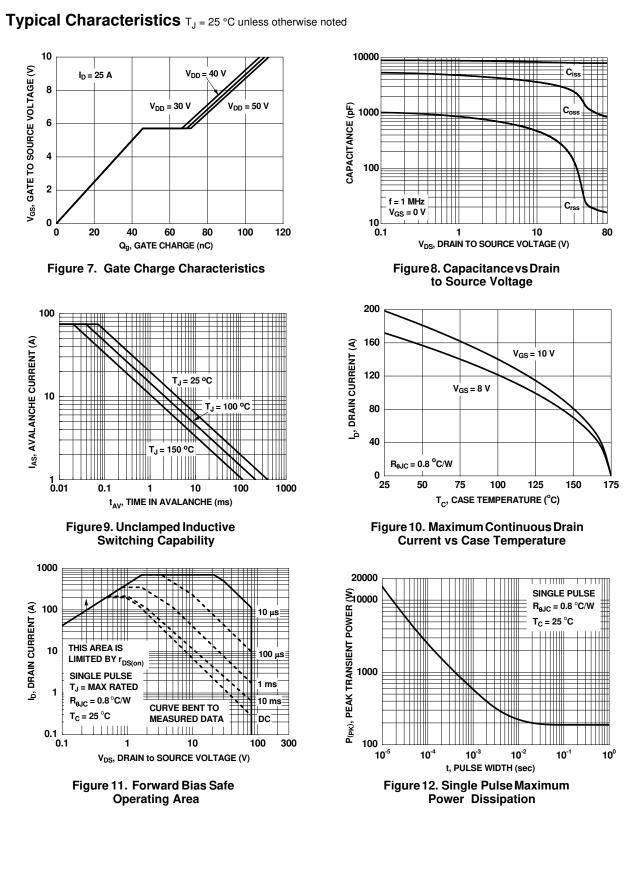
5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

nC

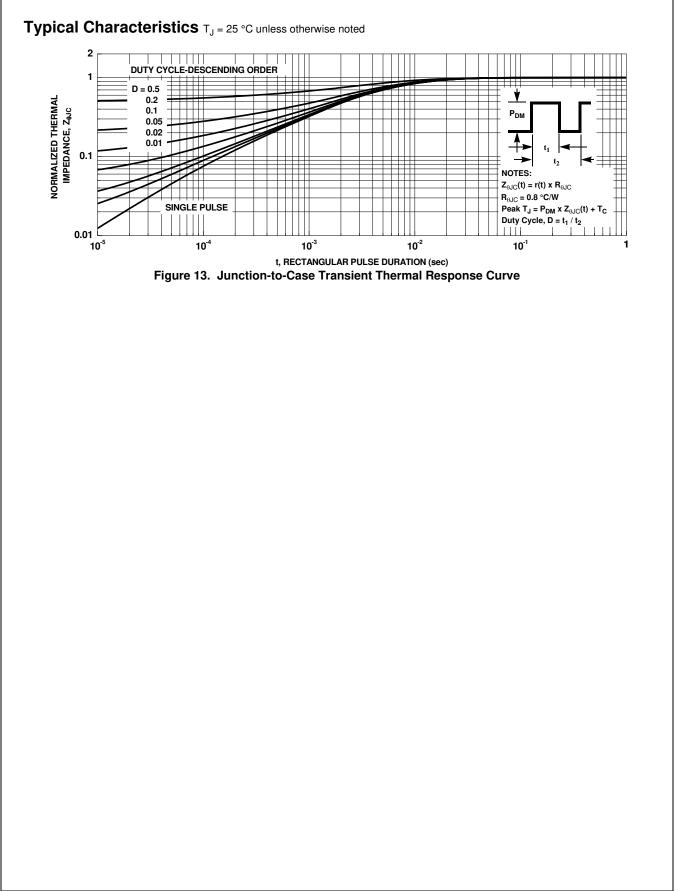
FDMS86350ET80 N-Channel PowerTrench<sup>®</sup> MOSFET



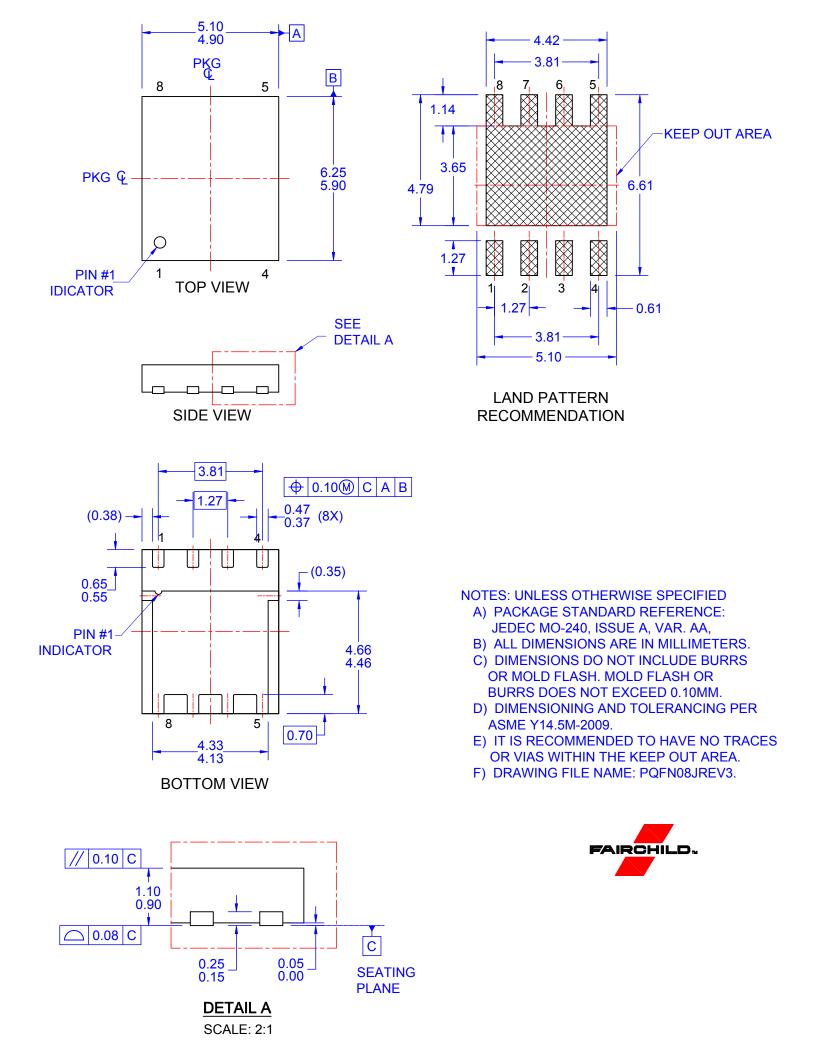
©2015 Fairchild Semiconductor Corporation FDMS86350ET80 Rev. C



FDMS86350ET80 N-Channel PowerTrench<sup>®</sup> MOSFET



FDMS86350ET80 N-Channel PowerTrench<sup>®</sup> MOSFET



ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC